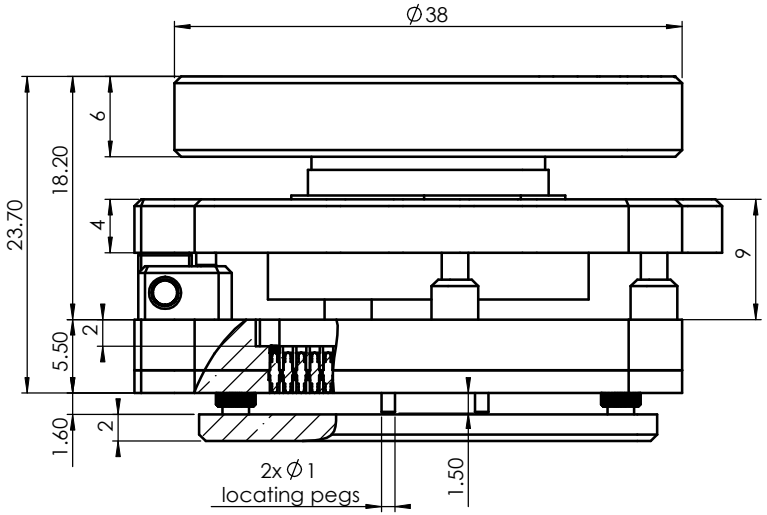
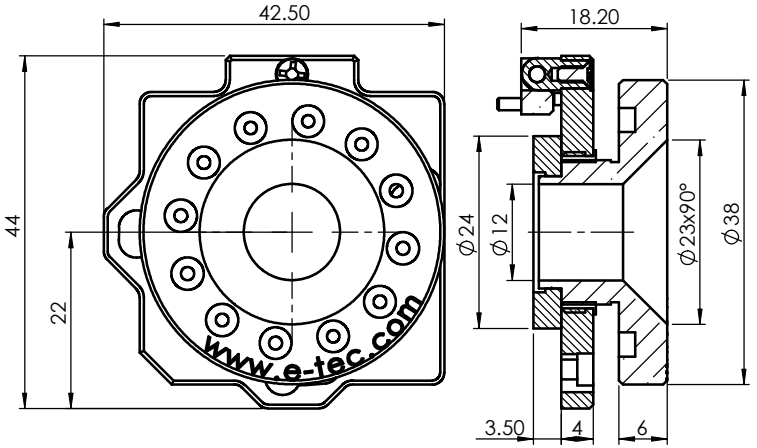
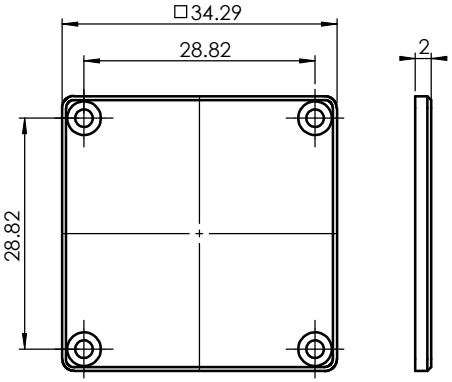
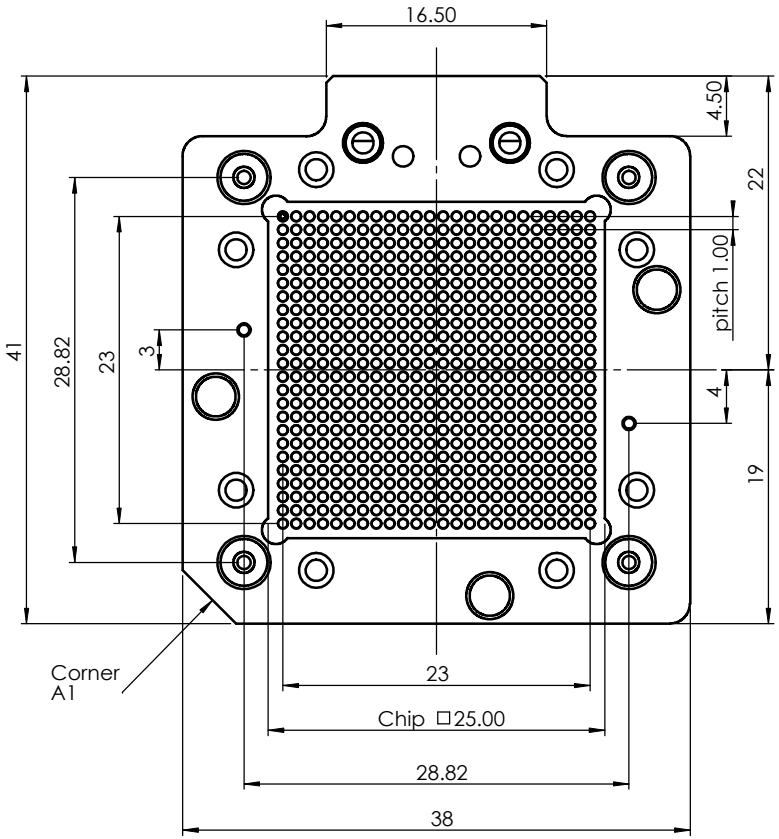


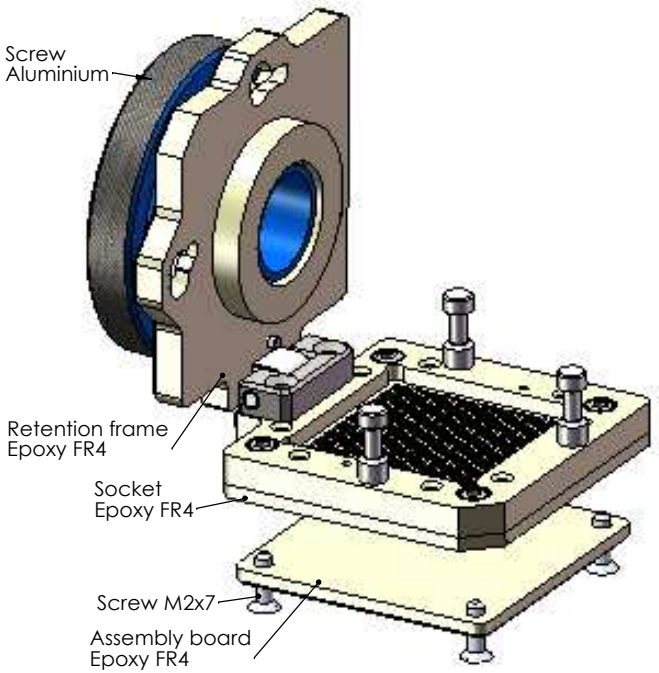


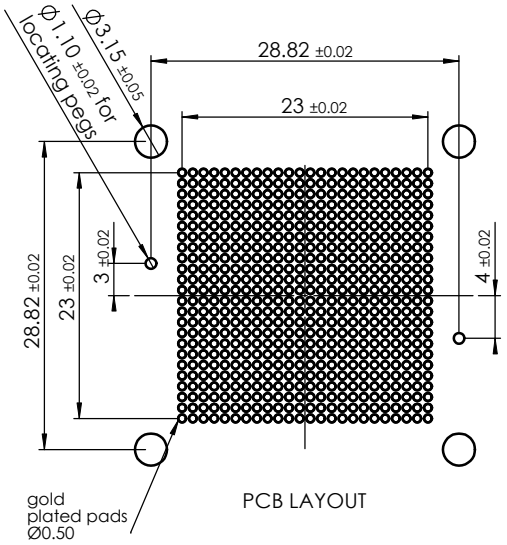
RETENTION FRAME



ASSEMBLY BOARD







PCB LAYOUT

UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN MILLIMETERS
SURFACE FINISH:
GENERAL TOLERANCES ISO 2768m

Remark: BGA Economic Clamshell socket, 576 pins,Pitch 1.00mm, matrix 24x24 Retention frame, Solderless

Patented		Visa	Date	Drawn by	Date	Visa
DRAWN		sme	27.08.2010	sme	27.08.2010	
CHK'D						
APPV'D		sme	27.08.2010			

Echelle: 2.5:1

MATERIAL: .

WEIGHT:

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"Production code"

BPE0576-10-09542-24AAA-L 0 Revision

SHEET 1 OF 1